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SEMICONDUCTOR

74ABT16501 18-Bit Universal Bus Transceivers with 3-STATE Outputs

General Description

The ABT16501 18-bit universal bus transceiver combines D-type latches and D-type flip-flops to allow data flow in transparent, latched, and clocked modes.

Data flow in each direction is controlled by output-enable (OEAB and \overline{OEBA}), latch-enable (LEAB and LEBA), and clock (CLKAB and CLKBA) inputs. For A-to-B data flow, the device operates in the transparent mode when LEAB is HIGH. When LEAB is LOW, the A data is latched if CLKAB is held at a HIGH or LOW logic level. If LEAB is LOW, the A bus data is stored in the latch/flip-flop on the LOW-to-HIGH transition of CLKAB. Output-enable OEAB is active-high. When OEAB is HIGH, the outputs are active. When OEAB is LOW, the outputs are in the high-impedance state.

Data flow for B to A is similar to that of A to B but uses $\overline{\text{OEBA}},$ LEBA, and CLKBA. The output enables are com-

plementary (OEAB is active HIGH and $\overline{\text{OEBA}}$ is active LOW).

To ensure the high-impedance state during power up or power down, OE inputs should be tied to GND through a pulldown resistor; the minimum value of the resistor is determined by the current-sourcing capability of the driver.

Features

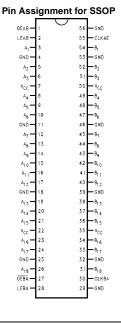
- Combines D-Type latches and D-Type flip-flops for operation in transparent, latched, or clocked mode
- Flow-through architecture optimizes PCB layout
- Guaranteed latch-up protection
- High impedance glitch free bus loading during entire power up and power down cycle
- Non-destructive hot insertion capability

Ordering Code:

Order Number	Package Number	Package Description
74ABT16501CSSC	MS56A	56-Lead Shrink Small Outline Package (SSOP), JEDEC MO-118, 0.300" Wide
74ABT16501CMTD	MTD56	56-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 6.1mm Wide

Devices also available in Tape or Reel. Specify by appending the suffix letter "X" to the ordering code.

Connection Diagram



Function Table (Note 1)

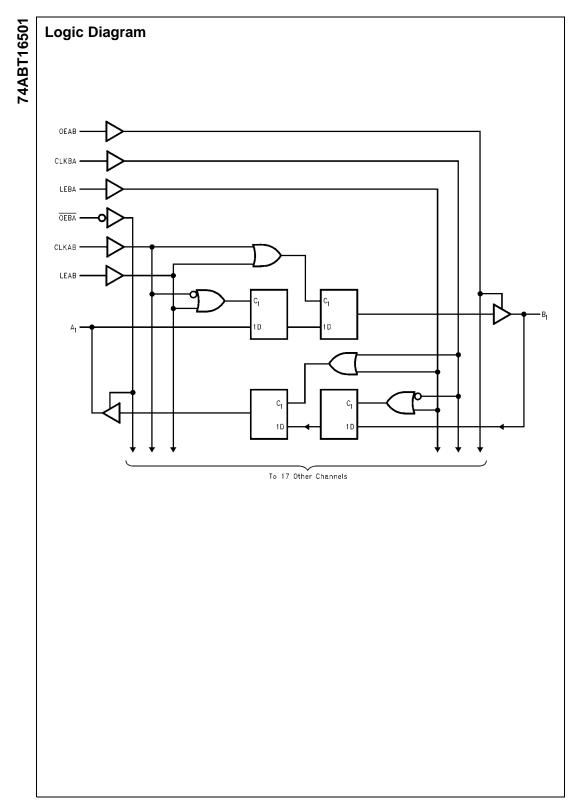
	Output				
OEAB	DEAB LEAB CLKAB A				
L	Х	Х	Х	Z	
Н	Н	Х	L	L	
Н	Н	Х	н	н	
н	L	Ŷ	L	L	
н	L	Ŷ	н	н	
н	L	н	Х	B ₀ (Note 2)	
Н	L	L	Х	B ₀ (Note 2) B ₀ (Note 3)	

Note 1: A-to-B data flow is shown: B-to-A flow is similar but uses $\overline{\text{OEBA}},$ LEBA, and CLKBA.

Note 2: Output level before the indicated steady-state input conditions were established.

Note 3: Output level before the indicated steady-state input conditions were established, provided that CLKAB was HIGH before LEAB went LOW.

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Absolute Maximum Ratings(Note 4)

Storage Temperature	-65°C to +150°C	
Ambient Temperature under Bias	-55°C to +125°C	
Junction Temperature under Bias	-55°C to +150°C	
V _{CC} Pin Potential to		
Ground Pin	-0.5V to +7.0V	
Input Voltage (Note 5)	-0.5V to +7.0V	
Input Current (Note 5)	-30 mA to +5.0 mA	
Voltage Applied to Any Output		
in the Disabled or		
Power-off State	-0.5V to 5.5V	
in the HIGH State	–0.5V to V _{CC}	
Current Applied to Output		
in LOW State (Max)	twice the rated $I_{OL} \left(\text{mA} \right)$	

DC Latchup Source Current Over Voltage Latchup (I/O)

Recommended Operating Conditions

Free Air Ambient Temperature	$-40^{\circ}C$ to $+85^{\circ}C$
Supply Voltage	+4.5V to +5.5V
Minimum Input Edge Rate ($\Delta V/\Delta t$)	
Data Input	50 mV/ns
Enable Input	20 mV/ns
Note 4: Absolute maximum ratings are values may be damaged or have its useful life impo- under these conditions is not implied.	

74ABT16501

–500 mA 10V

Note 5: Either voltage limit or current limit is sufficient to protect inputs.

DC Electrical Characteristics

Symbol	Parameter	Min	Тур	Max	Units	v _{cc}	Conditions
V _{IH}	Input HIGH Voltage	2.0			V		Recognized HIGH Signal
V _{IL}	Input LOW Voltage	1		0.8	V		Recognized LOW Signal
V _{CD}	Input Clamp Diode Voltage	1		-1.2	V	Min	I _{IN} = -18 mA
V _{OH}	Output HIGH Voltage	2.5			V	Min	I _{OH} = -3 mA
		2.0			V	Min	$I_{OH} = -32 \text{ mA}$
V _{OL}	Output LOW Voltage	1		0.55	V	Min	I _{OL} = 64 mA
IIH	Input HIGH Current			1	μA	Max	V _{IN} = 2.7V (Note 6)
				1			$V_{IN} = V_{CC}$
I _{BVI}	Input HIGH Current Breakdown Test			7	μA	Max	V _{IN} = 7.0V
IIL	Input LOW Current			-1	μA	Max	V _{IN} = 0.5V (Note 6)
				-1			$V_{IN} = 0.0V$
V _{ID}	Input Leakage Test	4.75			V	0.0	I _{ID} = 1.9 μA
							All Other Pins Grounded
I _{IH} +	Output Leakage Current			10	μΑ	0-5.5V	$V_{OUT} = 2.7V; \overline{OE}, OE = 2.0V$
I _{OZH}							
I _{IL} +	Output Leakage Current			-10	μΑ	0-5.5V	$V_{OUT} = 0.5V; \overline{OE}, OE = 2.0V$
I _{OZL}							
I _{OS}	Output Short-Circuit Current	-100		-275	mA	Max	V _{OUT} = 0V
I _{CEX}	Output HIGH Leakage Current			50	μΑ	Max	$V_{OUT} = V_{CC}$
I _{ZZ}	Bus Drainage Test			100	μΑ	0.0	V _{OUT} = 5.5V; All Others GND
I _{CCH}	Power Supply Current			1.0	mA	Max	All Outputs HIGH
I _{CCL}	Power Supply Current			68	mA	Max	An or Bn Outputs LOW
I _{CCZ}	Power Supply Current			1.0	mA	Max	$\overline{OE}_n = V_{CC}$,
							All Others at V _{CC} or GND
ICCT	Additional I _{CC} /Input	-		2.5	mA	Max	$V_{I} = V_{CC} - 2.1V$
							All Others at V _{CC} or GND
ICCD	Dynamic I _{CC} No Load	-			mA/	Max	Outputs Open
0	(Note 6)			0.23	MHz		Transparent Mode
							One Bit Toggling, 50% Duty Cyc

Note 6: Guaranteed, but not tested.

74ABT16501

DC Electrical Characteristics

Symbol	-		Тур	Мах	Units	v _{cc}	Conditions $C_L = 50 \text{ pF}; R_L = 500\Omega$
V _{OLP}	Quiet Output Maximum Dynamic V _{OL}		0.7	1.2	V	5.0	T _A = 25°C (Note 7)
V _{OLV}	Quiet Output Minimum Dynamic V _{OL}	-1.5	-1.0		V	5.0	T _A = 25°C (Note 7)
V _{OHV}	Minimum HIGH Level Dynamic Output Voltage	2.5	3.0		V	5.0	T _A = 25°C (Note 8)
V _{IHD}	Minimum HIGH Level Dynamic Input Voltage	2.2	1.8		V	5.0	T _A = 25°C (Note 9)
V _{ILD}	Maximum LOW Level Dynamic Input Voltage		1.2	0.8	V	5.0	T _A = 25°C (Note 9)

Note 7: Max number of outputs defined as (n). n - 1 data inputs are driven 0V to 3V. One output at LOW. Guaranteed, but not tested. Note 8: Max number of outputs defined as (n). n - 1 data inputs are driven 0V to 3V. One output HIGH. Guaranteed, but not tested.

Note 9: Max number of data inputs (n) switching. n - 1 inputs switching 0V to 3V. Input-under-test switching: 3V to threshold (V_{ILD}), 0V to threshold (V_{ILD}).

Guaranteed, but not tested.

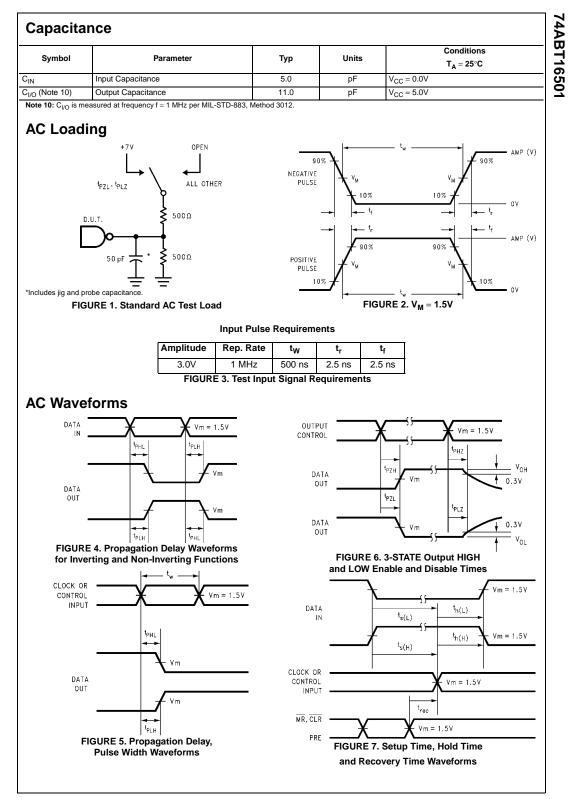
AC Electrical Characteristics

Symbol	Parameter		$T_{A} = +25^{\circ}C$ $V_{CC} = +5V$ $C_{L} = 50 \text{ pF}$			$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$ $V_{CC} = 4.5V - 5.5V$ $C_L = 50 \text{ pF}$	
		Min	Тур	Max	Min	Max	
f _{max}	Maximum Clock Frequency	150	200		150		MHz
t _{PLH}	Propagation Delay	1.0	2.7	4.6	1.0	4.6	ns
t _{PHL}	A or B to B or A	1.0	3.2	4.6	1.0	4.6	
t _{PLH}	Propagation Delay	1.0	3.1	5.0	1.0	5.0	ns
t _{PHL}	LEAB or LEBA to B or A	1.0	3.6	5.5	1.0	5.5	
t _{PLH}	Propagation Delay	1.0	3.4	5.3	1.0	5.3	ns
t _{PHL}	CLKAB or CLKBA to B or A	1.0	3.7	5.3	1.0	5.3	
t _{PZH}	Propagation Delay	1.5	2.7	5.6	1.5	5.6	ns
t _{PZL}	OEAB or OEBA to B or A	1.5	3.0	5.6	1.5	5.6	
t _{PHZ}	Propagation Delay	1.5	3.7	6.0	1.5	6.0	ns
t _{PLZ}	OEAB or OEBA to B or A	1.5	3.2	6.0	1.5	6.0	

AC Operating Requirements

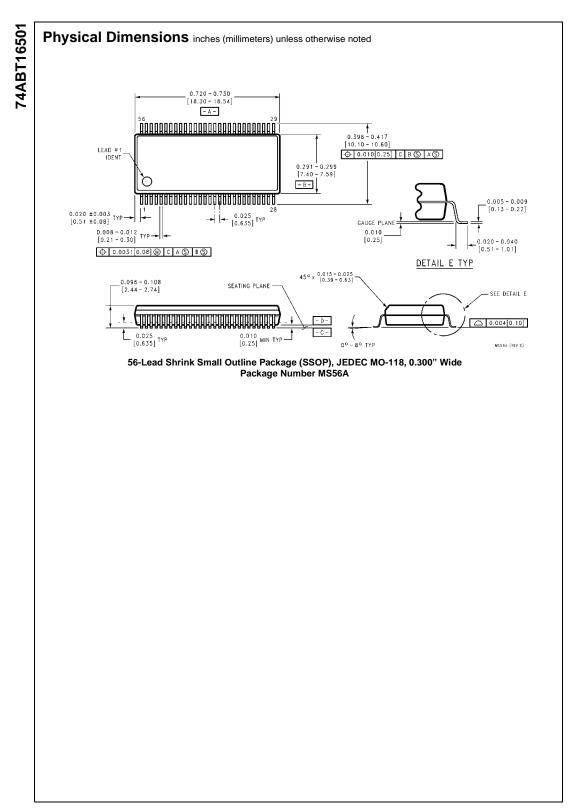
Symbol		T _A = +25°C		T _A = -40°		
	Parameter		= + 5V	V _{CC} = 4	Units	
		C _L =	50 pF	$C_L = 50 \text{ pF}$		
		Min	Max	Min	Max	1
t _S (H)	Setup Time,	4.0		4.0		ns
t _S (L)	A to CLKAB, B to CLKBA	4.0		4.0		
t _H (H)	Hold Time,	0		0		ns
t _H (L)	A to CLKAB, B to CLKBA	0		0		
t _S (H)	Setup Time, A to LEAB	4.0		4.0		ns
t _S (L)	or B to LEBA, CLK HIGH	4.0		4.0		
t _H (H)	Hold Time, A to LEAB	1.5		1.5		ns
t _H (L)	or B to LEBA, CLK HIGH	1.5		1.5		
t _S (H)	Setup Time, A to LEAB	1.5		1.5		ns
t _s (L)	or B to LEBA, CLK LOW	1.5		1.5		
t _H (H)	Hold Time, A to LEAB	1.5		1.5		
t _H (L)	or B to LEBA, CLK LOW	1.5		1.5		ns
t _W (H)	Pulse Width,	3.3		3.3		ns
t _W (L)	LEAB or LEBA, HIGH	3.3		3.3		
t _W (H)	Pulse Width, CLKAB	3.3		3.3		ns
t _W (L)	or CLKBA, HIGH or LOW	3.3		3.3		

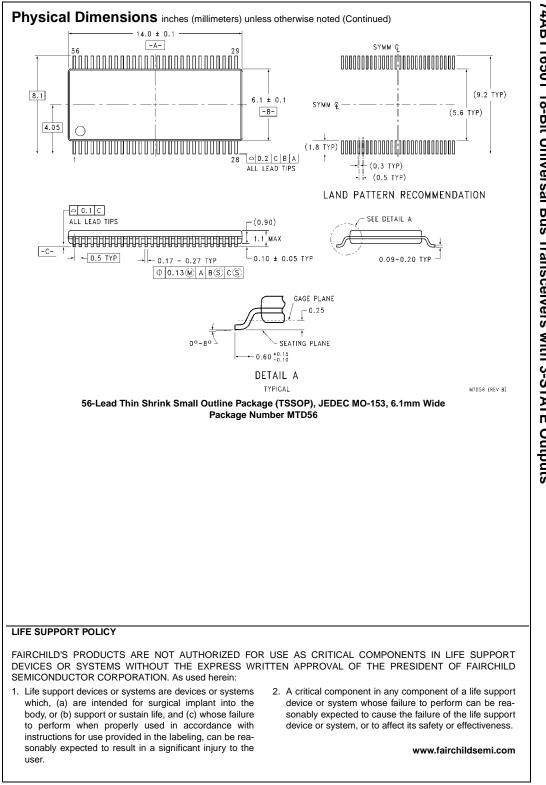
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5





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